ALLIANCE & CORIOLIS Checker Toolkit

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Toolkit Purpose

This toolkit has been created to allow developpers to share through <code>git</code> a set of benchmarks to validate their changes in Alliance & Coriolis before committing and pushing them in their central repositories. A change will be considered as validated when all the developpers can run successfully all the benchs in their respective environments.

As a consequence, this repository is likely to be *very* unstable and the commits not well documenteds as they will be quick corrections made by the developpers.

Toolkit Contents

The toolkit provides:

· Eleven benchmark designs:

Design	Technology	Cell Libraries
adder	MOSIS	nsxlib, mpxlib, msplib
AM2901 (standard cells)	Alliance dummy	sxlib, pxlib
AM2901 (datapath)	Alliance dummy	sxlib, dp_sxlib, pxlib
alliance-run (AM2901)	Alliance dummy	sxlib, dp_sxlib, padlib
CPU	MOSIS	nsxlib, mpxlib, msplib
SNX	MOSIS	nsxlib, mpxlib, msplib
мірѕ (microprogrammed)	Alliance dummy	sxlib, dp_sxlib, rf2lib
мірѕ (pipeline)	Alliance dummy	sxlib, dp_sxlib, rf2lib
мірs (pipeline+chip)	Alliance dummy	sxlib, dp_sxlib, rf2lib, pxlib
FPGA (Moc4x4_L4C12)	Alliance dummy	sxlib
ISPD05 (bigblue1)	Aucune	Genérée à la volée.

• Three cell libraries.

All thoses libraries are for use with the MOSIS technology. We provides them as part of

the toolkit as we are still in the process of validating that technology, and we may have to perform quick fixes on them. The design are configured to use them instead of those supplied by the ALLIANCE installation.

- nsxlib: Standard Cell library.
- mpxlib: Pad library, compliant with CORIOLIS.
- msplib: Pad library, compliant with ALLIANCE / ring. Cells in this library are wrappers around their counterpart in mpxlib, they provides an outer layout shell that is usable by ring.
- The RDS file for the MOSIS technology scn6m_deep_09.rds, for the same reason as the cell libraries.
- · Miscellenous helper scripts.

Benchmark Makefiles

The main body of the Makefile has been put into benchs/etc/rules.mk.

The Makefile provides some or all of the following targets. If the place and route stage of a bench can be done by both CORIOLIS and ALLIANCE an alliance/ subdirectory will be present.

	layout	The complete symbolic layout of the design (P&R).
	gds	Generate the real layout (GDSII)
	druc	Symbolic layout checking
CORIOLIS	lvx	Perform LVS.
CORIOLIS	graal	Launch graal in the Makefile's environement
	dreal	Launch dreal in the Makefile 's environement, and
		load the gds file of the design.
	view	Launch cgt and load the design (chip)
	cgt	Launch cgt in the Makefile 's environement

A top Makefile in a bench directory must looks like:

```
BOOMOPT = -A
BOOGOPT =
LOONOPT =
NSL2VHOPT = -vasy
LIBRARY_FAMILY = nsxlib
USE_SYNTHESIS = Yes
USE_CLOCKTREE = No
USE_DEBUG = No

NETLISTS = cla16 \
inc16 \
reg4 \
type_dec \
alu16_model \
snx_model
```

include ../etc/rules.mk

lvx: lvx-chip_kite
druc: druc-chip_kite
view: cgt-chip_kite

layout: chip_kite.ap
gds: chip_kite.gds

Where variables have the following meaning:

Variable	Usage
NETLISTS	The list of <i>netlists</i> that are requireds to perform the place and route stage. The files must we given <i>without</i> extension. According to the value of <code>USE_SYNTHESIS</code> they are user supplied or generated. In the later case, be aware that calling the <code>clean</code> target will remove the generated files.
LIBRARY_FAMILY	Tells which library set to use. Legal values are sxlib (default) and nsxlib (Mosis technology).
USE_SYNTHESIS	If set to Yes, then the files given in the NETLISTS variables will be synthetised from the reference vhdl or nsl description, if this tool is available. Note that the clean will remove all generated files.
USE_CLOCKTREE	Adds a clock-tree to the design (CORIOLIS).
USE_DEBUG	Activate debug support on cgt.

CORIOLIS Configuration Files

Unlike Alliance which is entirely configured through environement variables or system-wide configuration file, Coriolis uses configuration files in the current directory. They are present for each bench:

- <cwd>/.coriolis2/techno.py: Select which symbolic and real technology to use.
- <cwd>/.coriolis2/settings.py: Override for any system configuration, except for the technology.

CORIOLIS and Clock Tree Generation

When CORIOLIS is used, it create a clock tree which modificate the original netlist. The new netlist, with a clock tree, has a postfix of clocked.

Note



Trans-hierarchical Clock-Tree. As CORIOLIS do not flatten the designs it creates, not only the top-level netlist is modificated. All the sub-blocks connected to the master clock are also duplicateds, whith the relevant part of the clock-tree included.

RHEL6 and Clones

Under RHEL6 the developpement version of CORIOLIS needs the devtoolset-2. rules.mk tries, based on uname to switch it on or off.

Benchmarks Special Notes

alliance-run

This benchmark comes mostly with it's own rules and do not uses the ones supplieds by rules.mk. It uses only the top-level configuration variables.

It a sligtly modified copy of the alliance-run found in the ALLIANCE package (modification are all in the Makefile). It build an AM2901, but it is splitted in a control and an operative part (data-path). This is to also check the data-path features of ALLIANCE.

And lastly, it provides a check for the CORIOLIS encapsulation of ALLIANCE through PYTHON wrappers. The support is still incomplete and should be used only by very experienced users. See the demo* rules.

Libraries Makefiles

The bench/etc/rules.mk provides rules to perform the check of a library as a whole or cell by cell. To avoid too much clutter in the library directory, all the intermediate files generated by the verification tools are kept in a ./check/ subdirectory. Once a cell has been validated, a ./check/<cell>.ok is generated too prevent it to be checked again in subsequent run. If you want to force the recheck of the cell, do not forget to remove this file.

The checking procedure:

- DRC with druc.
- Formal proof between the layout and the behavioral description. This is a somewhat long chain of tools:
 - 1. cougar, extract the spice netlist (.spi).
 - 2. yagle, rebuild a behavioral description (.vhd) from the spice netlist.
 - 3. vasy, convert the .vhd into a .vbe (Alliance VHDL subset for behavioral descriptions).
 - 4. proof, perform the formal proof between the refence .vbe and the extracted one.

Rule or File	Action
check-lib	Validate every cell of the library
clean-lib-tmp	Remove all intermediate files in the . /check subdirectory except for the *.ok ones. That is, cells validated will not be rechecked.
clean-lib	Remove all files in ./check, including *.ok
./check/ <cell>.ok</cell>	Use this rule to perform the individual check of <cell>. If the cell is validated, a file of the same name will be created, preventing the cell to be checked again.</cell>

Tools & Scripts

One script to run them all: go.sh

To call all the bench's Makefile sequentially and execute one or more rules on each, the small script utility go.sh is available. Here are some examples:

```
dummy@lepka:bench$ ./bin/go.sh clean
dummy@lepka:bench$ ./bin/go.sh lvx
```

Command Line cgt: doChip.py

As a alternative to cgt, the small helper script doChip.py allows to perform all the P&R tasks, on an stand-alone block or a whole chip.

Pad Layout Converter px2mpx.py

The px2mpx.py script convert pad layout from the pxlib (ALLIANCE dummy technology) into mpxlib (MOSIS compliant symbolic technology).

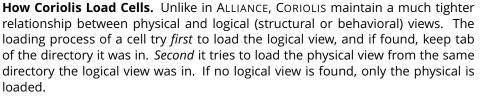
Basically it multiplies all the coordinate by two as the source technology is 1μ type and the target one a 2μ . In addition it performs some adjustement on the wire extension and minimal width and the blockage sizes.

As it is a one time script, it is heavily hardwired, so before using it do not forget to edit it to suit your needs.

The whole conversion process is quite tricky as we are cheating with the normal use of the software. The steps are as follow:

- 1. Using the Alliance dummy technology and in an empty directory, run the script. The layouts of the converted pads (*_mpx.ap) will be created.
- 2. In a second directory, this time configured for the MoSIS technology (see .coriolis2_techno.conf) copy the converted layouts. In addition to the layouts, this directory must also contain the behavioral description of the pads (.vbe). Otherwise, you will not be able to see the proper layout.
- 3. When you are satisfied with the new layout of the pads, you can copy them back in the official pad cell library.

Note





Conversely, when saving a cell, the directory it was loaded from is kept, so that the cell will be overwritten, and not duplicated in the working directory as it was in ALLIANCE.

This explains why the behavioral view of the pad is needed in the directory the layouts are put into. Otherwise you would only see the pads of the system library (if any).

Yagle Cell Extraction Script extractCell.tcl

A small TCL script for avt_shell to perform a cell extraction with yagle. Cell which name starts by sff will be treated as D flip-flop.

CADENCE Support

To perform comparisons with CADENCE EDI tools (i.e. encounter NANOROUTE), some benchmarks have a sub-directory encounter holding all the necessary files. Here is an example for the design named <fpga>.

encounter directory	
File Name	Contents
fpga_export.lef	Technology & standard cells for the design
fpga_export.def	The design itself, flattened to the standard cells.
fpga_nano.def	The placed and routed result.
fpga.tcl	The TCL script to be run by encounter

The LEF/DEF file exported or imported by Coriolis are *not* true physical files. They are pseudoreal, in the sense that all the dimensions are directly taken from the symbolic with the simple rule 1 lambda = 1 micron.

Note



LEF/DEF files: Coriolis is able to import/export in those formats only if it has been compiled against the S₁₂ relevant libraries that are subjects to specific license agreements. So in case we don't have access to thoses we supplies the generated LEF/DEF files.

The encounter directory contains the LEF/DEF files and the TCL script to be run by encounter:

```
ego@home:encounter> . ../../etc/EDI1324.sh
ego@home:encounter> encounter -init ./fpga.tcl
```

Example of TCL script for encounter:

```
suppressMessage ENCEXT-2799
loadLefFile fpga_export.lef
loadDefFile fpga_export.def
floorPlan -site core -r 0.998676319592 0.95 0.0 0.0 0.0 0.0
getIoFlowFlag
fit
setDrawView place
setPlaceMode -fp false
placeDesign
generateTracks
generateVias
setNanoRouteMode -quiet -drouteFixAntenna 0
setNanoRouteMode -quiet -drouteStartIteration 0
setNanoRouteMode -quiet -routeTopRoutingLayer 5
setNanoRouteMode -quiet -routeBottomRoutingLayer 2
setNanoRouteMode -quiet -drouteEndIteration 0
setNanoRouteMode -quiet -routeWithTimingDriven false
setNanoRouteMode -quiet -routeWithSiDriven false
routeDesign -globalDetail
global dbgLefDefOutVersion
set dbgLefDefOutVersion 5.7
defOut -floorplan -netlist -routing fpga_nano.def
```

Technologies

We provides configuration files for the publicly available MOSIS technology SCN6M_DEEP.

- ./bench/etc/scn6m deep 09.rds, RDS rules for symbolic to real transformation.
- ./bench/etc/scn6m_deep.hsp, transistor spice models for yagle.

References:

- MOSIS Scalable CMOS (SCMOS)
- MOSIS Wafer Acceptance Tests

Technical informations:

MOSIS WAFER ACCEPTANCE TESTS

RUN: T92Y (MM_NON-EPI_THK-MTL) VENDOR: TSMC

TECHNOLOGY: SCN018 FEATURE SIZE: 0.18 microns

Run type: DED

INTRODUCTION: This report contains the lot average results obtained by MOSIS from measurements of MOSIS test structures on each wafer of this fabrication lot. SPICE parameters obtained from similar

measurements on a selected wafer are also attached.

COMMENTS: DSCN6M018_TSMC

TRANSISTOR PARAMETERS	W/L	N-CHANNEL	P-CHANNEL	UNITS
MINIMUM Vth	0.27/0.18	0.50	-0.49	
VUII		0.50	-0.49	VOILS
SHORT	20.0/0.18			
Idss		572	-276	uA/um
Vth		0.52	-0.49	volts
Vpt		4.7	-5.2	volts
WIDE	20.0/0.18			
Ids0		20.8	-15.2	pA/um
LARGE	50/50			
Vth		0.42	-0.41	volts
Vjbkd		3.7	-4.4	volts
Ijlk		<50.	.0 <	50.0 pA
K' (Uo∗Cox/2)		171.0	-37.0	uA/V^2
Low-field Mobility		406.07	87.86	$cm^2/V*s$

COMMENTS: Poly bias varies with design technology. To account for mask bias use the appropriate value for the parameters ${\tt XL}$ and ${\tt XW}$ in your SPICE model card.

in your SPIO	CE mode	el car	d.					
	Design	Tech	nology 			XL (ur	n) XW 	(um)
	SCN6M_	DEEP		a=0.09)		0.00		.01
	SCN6M_	SUBM	_	ck oxid a=0.10)	e	0.00 -0.02		.01
			thi	ck oxid	е	-0.02	0	.00
FOX TRANSISTORS Vth	GAT Pol		_		+ACTIVE U <-6	NITS	lts	
PROCESS PARAMETERS Sheet Resistance Contact Resistance	N+ 7.0 8.3		POLY 8.3 8.1	N+BLK 59.5	PLY+BLK 306.6	M1 0.08	M2 0.08 4.83	UNITS ohms/sq ohms

Gate Oxide Thickness 41

COMMENTS: DEEP_SUBMICRON

PROCESS PARAMETERS M3 POLY_HRI M4 M5

М6

N_W

angstrom

UNITS

Sheet Resistance Contact Resistance	0.08	100.	1_111(1	(0.08 5.30	3	0	.07 .50		0.0	1 9	51	ohms	
COMMENTS: BLK is silic	cide k	olock												
CAPACITANCE PARAMETERS	S N+	P+	POLY	M1	M2	МЗ	M4	M5	М6	R_W	D_N_W	M5P	N_W	UNI
Area (substrate)	969	1234	101	34	14	9	7	5	4		129		130	aF/ι
Area (N+active)			8517	53	20	14	11	9	8					aF/ι
Area (P+active)			8275											aF/ι
Area (poly)				64	17	10	7	5	4					aF/ι
Area (metal1)					35	14	9	6	5					aF/ι
Area (metal2)						36	14	9	6					aF/ι
Area (metal3)							37	14	9					aF/ι
Area (metal4)								36	14					aF/ι
Area (metal5)									35			1039		aF/ι
Area (r well)	953													aF/ι
Area (d well)										562				aF/ι
Area (no well)	140													aF/ι
Fringe (substrate)	196	229						21						aF/ι
Fringe (poly)				68	38	29	23	19	18					aF/ι
Fringe (metal1)					49	34		22	20					aF/ι
Fringe (metal2)						45	35	27	23					aF/ι
Fringe (metal3)							54	34	30					aF/ι
Fringe (metal4)								63	43					aF/ι
Fringe (metal5)									66					aF/ı
CIRCUIT PARAMETERS						τ	UNI'	TS						
Inverters		I	K											
Vinv		1	. 0	(0.7	4 ,	vol	ts						
Vinv		1	. 5	(0.79	9 7	vol	ts						
Vol (100 uA)		2	. 0	(0.0	3 7	vol	ts						
Voh (100 uA)		2	. 0		1.62	2 7	vol	ts						
Vinv		2	. 0	(0.83	3 7	vol	ts						
Gain		2	. 0	-2	4.6	7								
Ring Oscillator Freq.														
D1024_THK (31-stg,3.	.3V)			302	2.9	1 1	MHz							
DIV1024 (31-stg,1.8V	7)			37	7.1	3 1	MHz							
Ring Oscillator Power	-													
D1024_THK (31-stg,3.	.3V)			(0.0	7 ι	uW/I	MHz,	/gat	te				
DIV1024 (31-stg,1.8V	7)			(0.02	2 1	uW/I	MHz,	/gat	te				